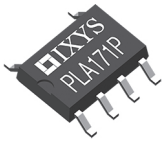
IXYS
INTEGRATED CIRCUITS DIVISION



PLA171
Single-Pole, Normally Open OptoMOS® Relay

Parameter	Rating	Units
Load Voltage	800	V_P
Load Current	100	mA_{rms} / mA_{DC}
On-Resistance (max)	50	Ω
Input Control Current	2	mA

Features

- 7mm Separation of Output Pins
- 800V_P Blocking Voltage
- 5000V_{rms} Input/Output Isolation
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small Surface Mount Package
- Flammability Rating UL 94 V-0

Applications

- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Automotive High-Voltage Circuitry
- Aerospace
- Industrial Controls

Description

Specially designed to provide 7mm of separation between the two output pins, IXYS Integrated Circuits' PLA171 is a single-pole, normally open (1-Form-A) Solid State Relay that uses optically coupled MOSFET technology to provide an enhanced input to output isolation of 5000V_{rms}.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

The PLA171 is designed to replace, and offers superior reliability over, electromechanical relays. This device provides bounce-free switching in a compact surface-mount package.

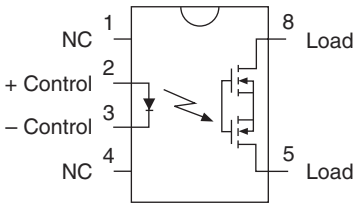
Approvals

- UL Certified Component: File E76270
- EN/IEC 60950-1 Certified Component: Certificate available on our website

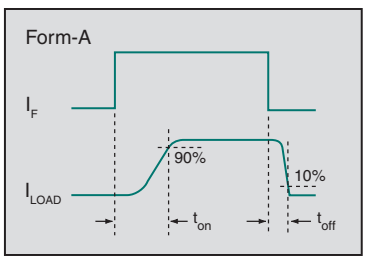
Ordering Information

Part #	Description
PLA171P	6-Pin (8-Pin Body) Flatpack (50/Tube)
PLA171PTR	6-Pin (8-Pin Body) Flatpack, Tape & Reel (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



ПРОМЭЛЕКТРОНИКА / sales@prom-elec.com

Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Blocking Voltage	800	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation [1]	150	mW
Total Power Dissipation [2]	800	mW
ESD, Human Body Model	8	kV
Isolation Voltage, Input to Output (60 Seconds)	5000	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

[1] Derate linearly 1.33 mW / ºC
[2] Derate linearly 6.67 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

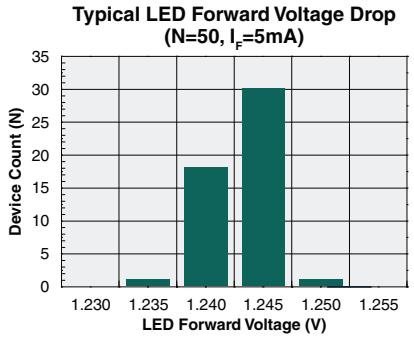
Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

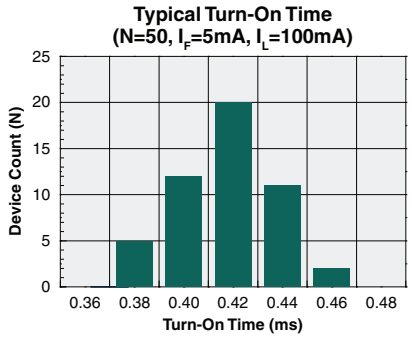
Electrical Characteristics @ 25ºC

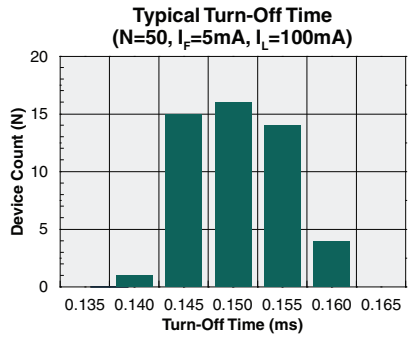
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous [1]	I_F=2mA	I_L	-	-	100	mA_{rms} / mA_{DC}
Peak	I_F=2mA , t=10ms	I_{LPK}	-	-	±350	mA_P
On-Resistance [2]	I_F=2mA, I_L= 100mA	R_{ON}	-	40	50	Ω
	I_F=5mA, I_L=1mA		-	70	85	
Off-State Leakage Current	I_F=0mA, V_L=800V_P	I_{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I_F=5mA, V_L=10V	t_{on}	-	0.42	5	ms
Turn-Off		t_{off}	-	0.15	5	
Output Capacitance	I_F=0mA, V_L=50V, f=1MHz	C_{OUT}	-	11	-	pF
Input Characteristics						
Input Control Current to Activate [3]	I_L=100mA	I_F	-	0.39	2	mA
Input Control Current to Deactivate	-	I_F	0.1	-	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.5	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Input to Output Capacitance	V_{IO}=0V, f=1MHz	C_{IO}	-	3	-	pF

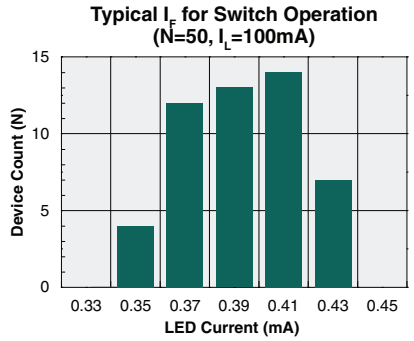
[1] Load derates linearly from 100mA @ 25ºC to 55mA @85ºC.
[2] Measurement taken within 1 second of on-time.
[3] For applications requiring high temperature operation (greater than 60ºC) a minimum LED drive current of 5mA is recommended.

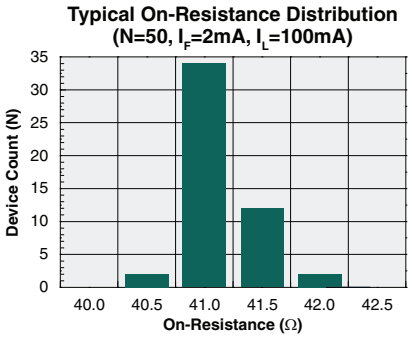
PERFORMANCE DATA*

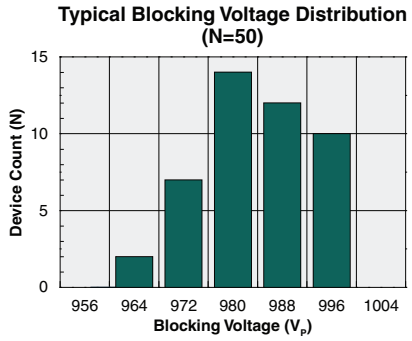








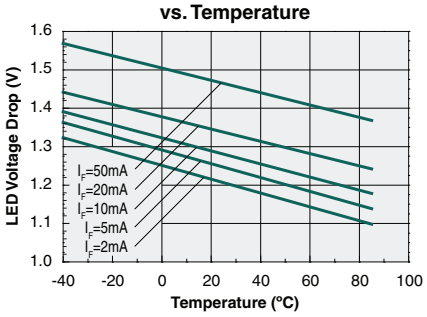




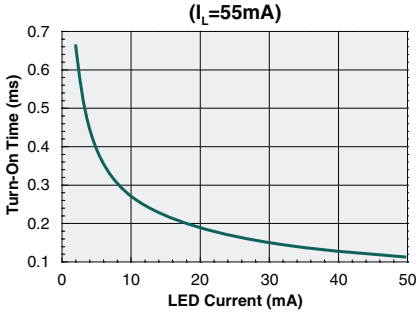
*Unless otherwise noted, data presented in these graphs is typical of device operation at 25ºC.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

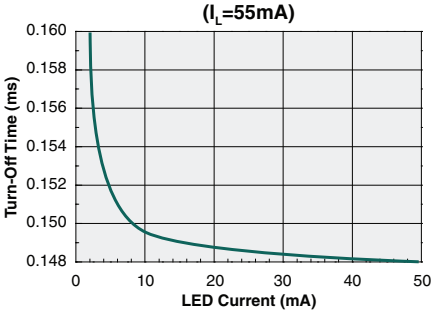
Typical LED Voltage Drop vs. Temperature



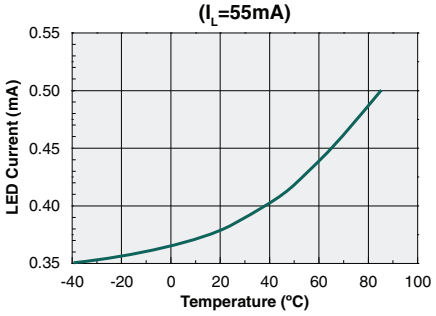
Typical Turn-On Time vs. LED Forward Current (I_L=55mA)



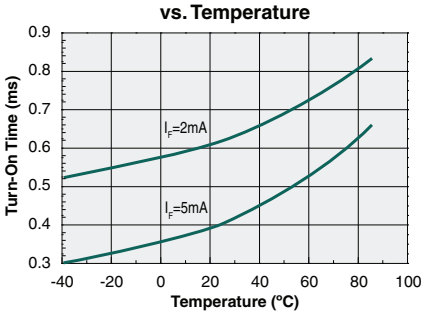
Typical Turn-Off Time vs. LED Forward Current (I_L=55mA)



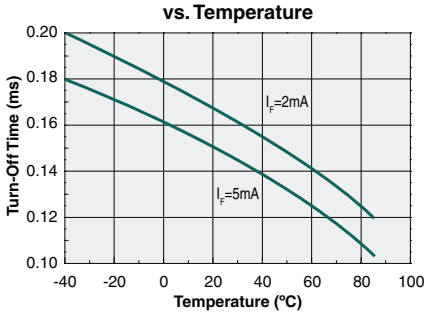
LED Current to Operate vs. Temperature (I_L=55mA)



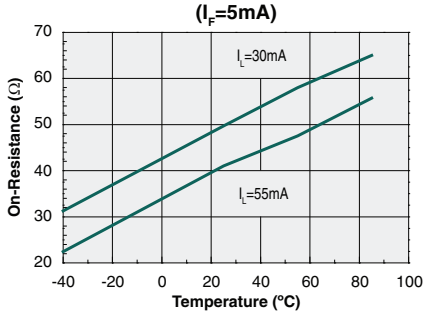
Typical Turn-On Time vs. Temperature



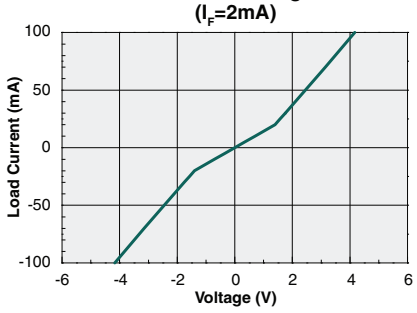
Typical Turn-Off Time vs. Temperature



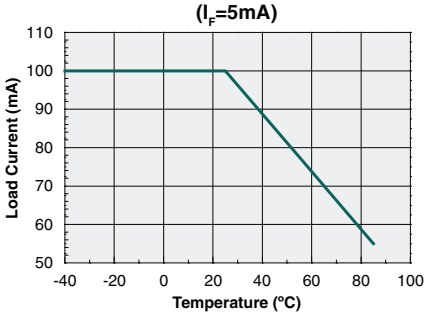
Typical On-Resistance vs. Temperature (I_F=5mA)



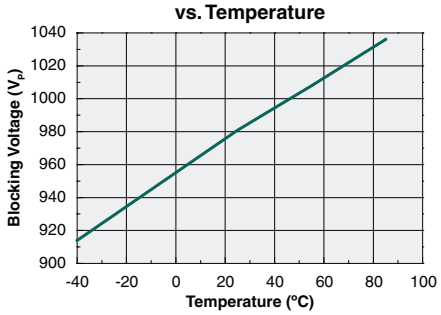
Typical Load Current vs. Load Voltage (I_F=2mA)



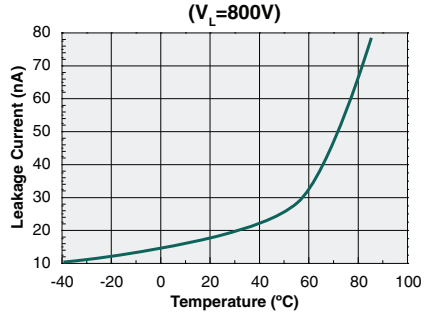
Maximum Load Current vs. Temperature (I_F=5mA)



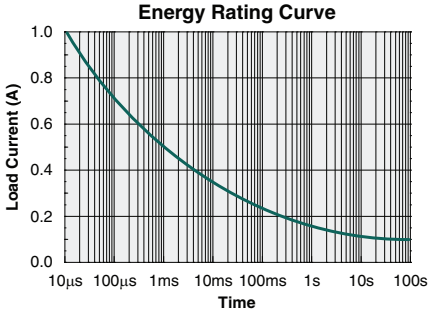
Typical Blocking Voltage vs. Temperature



Typical Leakage Current vs. Temperature (V_L=800V)



Energy Rating Curve



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25ºC.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
PLA171P	MSL 1

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Soldering Profile

Provided in the table below is the Classification Temperature (T_C) of this product and the maximum dwell time the body temperature of this device may be (T_C - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

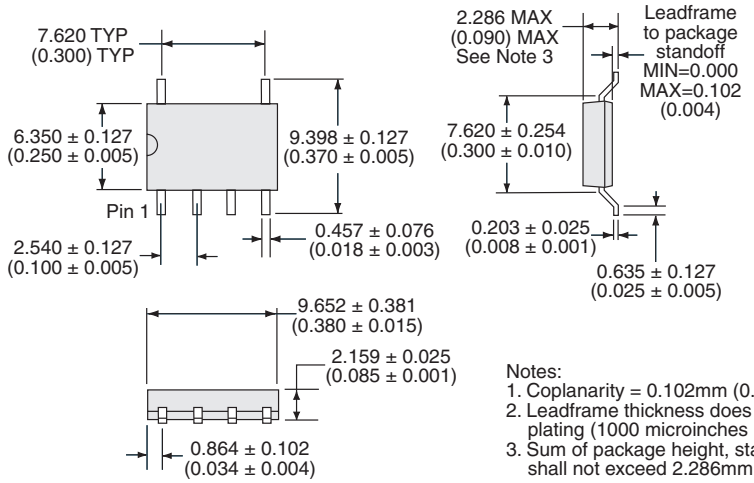
Device	Classification Temperature (T_c)	Dwell Time (t_p)	Max Reflow Cycles
PLA171P	260°C	30 seconds	3

Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

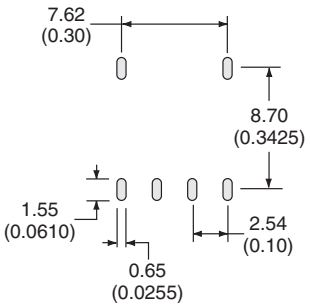
Mechanical Dimensions

PLA171P



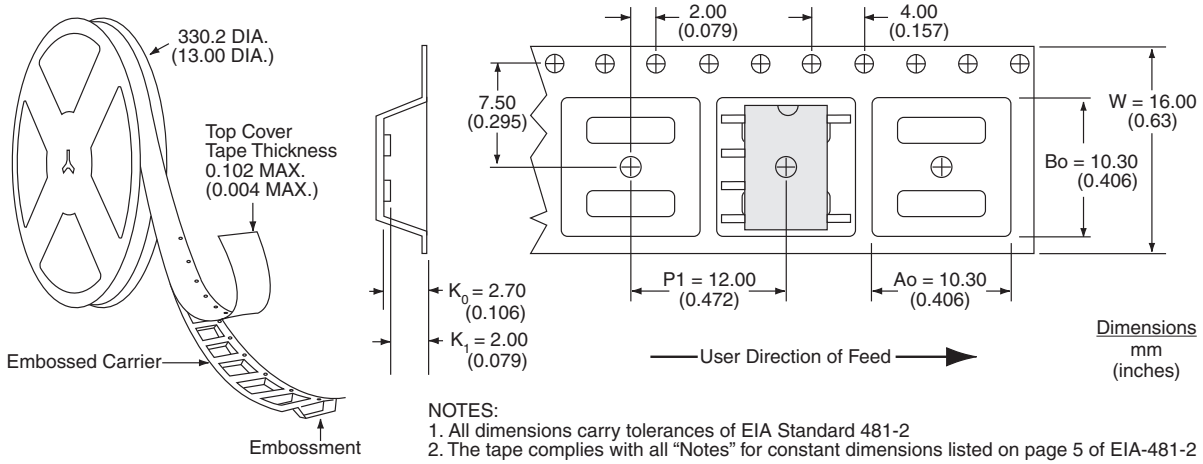
Notes:
1. Coplanarity = 0.102mm (0.004") MAX
2. Leadframe thickness does not include solder plating (1000 microinches MAX)
3. Sum of package height, standoff, and coplanarity shall not exceed 2.286mm (0.090")

Recommended PCB Land Pattern



Dimensions
mm
(inches)

PLA171PTR Tape & Reel



Dimensions
mm
(inches)

NOTES:
1. All dimensions carry tolerances of EIA Standard 481-2
2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com

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